VS-43CTQ...SPbF

## VS-43CTQ...SPbF, VS-43CTQ...-1PbF Series

Vishay Semiconductors

RoHS

COMPLIANT

**HALOGEN** 

FREE

# Schottky Rectifier, 2 x 20 A

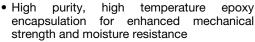
# Base common cathode cathode Anode Anode Anode Cathode Anode

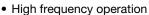
PRODUCT SUMMARY				
I <sub>F(AV)</sub>	2 x 20 A			
$V_{R}$	80 V/100 V			

VS-43CTQ...-1PbF

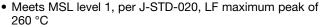
### **FEATURES**

- 175 °C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop





Guard ring for enhanced ruggedness and long term reliability



- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS Directive 2002/95/EC
- AEC-Q101 qualified

### **DESCRIPTION**

This center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	VALUES	UNITS				
I <sub>F(AV)</sub>	Rectangular waveform	40	А				
V <sub>RRM</sub>		80/100	V				
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	850	A				
V <sub>F</sub>	20 Apk, T <sub>J</sub> = 125 °C (per leg)	0.67	V				
T <sub>J</sub>	Range	- 55 to 175	°C				

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-43CTQ080SPbF VS-43CTQ080-1PbF	VS-43CTQ100SPbF VS-43CTQ100-1PbF	UNITS		
Maximum DC reverse voltage	$V_{R}$	80	100	V		
Maximum working peak reverse voltage	$V_{RWM}$	00	100	<b>v</b>		

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	SYMBOL TEST CONDITIONS		VALUES	UNITS
Maximum average per leg forward current per device			I <sub>F(AV)</sub> 50 % duty cycle at T <sub>C</sub> = 135 °C, rectangular waveform		20	•
					40	
Maximum peak one cycle non-repetitive surge current per leg See fig. 7			5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	850	A
		IFSM	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	275	
Non-repetitive avalanche energy per leg		E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 0.50 A, L = 60 mH		7.50	mJ
Repetitive avalanche current per leg		I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s  Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		0.50	Α



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ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS	
		20 A	T <sub>.1</sub> = 25 °C	0.81	
Maximum forward voltage drop per leg	V <sub>FM</sub> <sup>(1)</sup>	40 A	1j=25 C	0.98	V
See fig. 1	VFM (1)	20 A	T 105 °C	0.67	
		40 A	T <sub>J</sub> = 125 °C	0.81	
Maximum reverse leakage current per leg	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	V <sub>R</sub> = Rated V <sub>R</sub>	1	mA
See fig. 2		T <sub>J</sub> = 125 °C		11	
Threshold voltage	V <sub>F(TO)</sub>	T T manyimayan		0.71	V
Forward slope resistance	r <sub>t</sub>	$T_J = T_J$ maximum		0.43	mΩ
Maximum junction capacitance per leg	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal range	ge 100 kHz to 1 MHz), 25 °C	1480	pF
Typical series inductance per leg	L <sub>S</sub>	Measured lead to lead 5 mm from package body		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs

### Note

 $^{(1)}\,$  Pulse width < 300  $\mu s,$  duty cycle < 2 %

THERMAL - MECHAI	NICAL SPE	ECIFICAT	IONS		
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 175	°C
Maximum thermal resistance, junction to case per leg		Б	DC energica	2.0	
Maximum thermal resistance, junction to case per package		R <sub>thJC</sub>	DC operation	1.0	°C/W
Typical thermal resistance, case to heatsink		R <sub>thCS</sub> Mounting surface, smooth and greased		0.50	
Approximate weight				2	g
Approximate weight				0.07	OZ.
Manustina tauana	minimum			6 (5)	kgf · cm
Mounting torque	maximum			12 (10)	(lbf $\cdot$ in)
			Consisted D2DAV	43CTC	Q080S
Marking device			Case style D <sup>2</sup> PAK	43CTQ100S	
			C	43CTQ080-1	
			Case style TO-262	43CTQ100-1	





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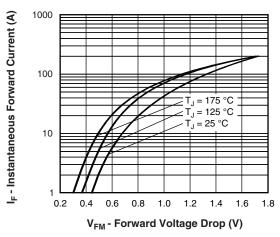


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

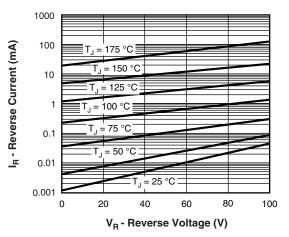


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

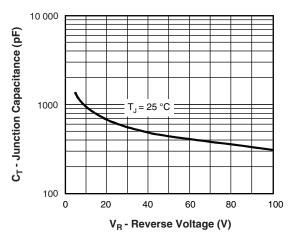


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

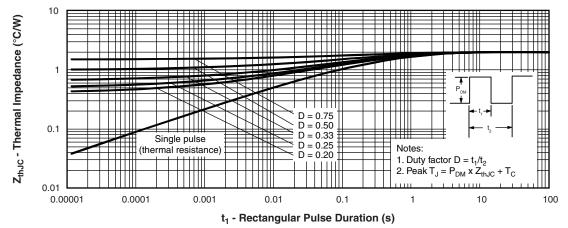


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)

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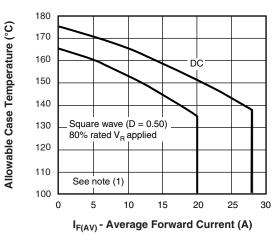


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

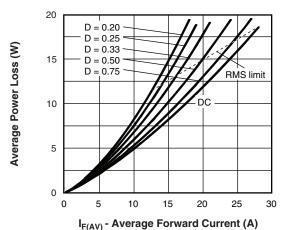


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

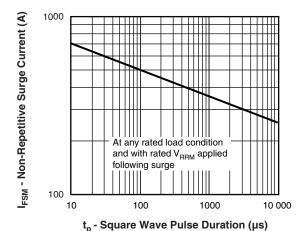


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

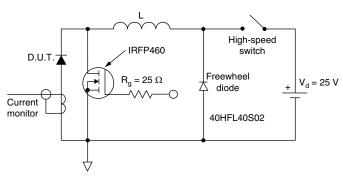


Fig. 8 - Unclamped Inductive Test Circuit

## Note

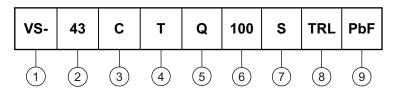
<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  $Pd_{REV} = Inverse power loss = V_{R1} \times I_R$  (1 - D);  $I_R$  at  $V_{R1} = 10$  V

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Vishay Semiconductors

## **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (40 A)

3 - Circuit configuration: C = Common cathode

**4** - T = TO-220

5 - Schottky "Q" series

6 - Voltage ratings - 080 = 80 V 100 = 100 V

7 - • S = D<sup>2</sup>PAK

• -1 = TO-262

**8** - • None = Tube (50 pieces)

• TRL = Tape and reel (left oriented - for D<sup>2</sup>PAK only)

• TRR = Tape and reel (right oriented - for D<sup>2</sup>PAK only)

9 - PbF = Lead (Pb)-free

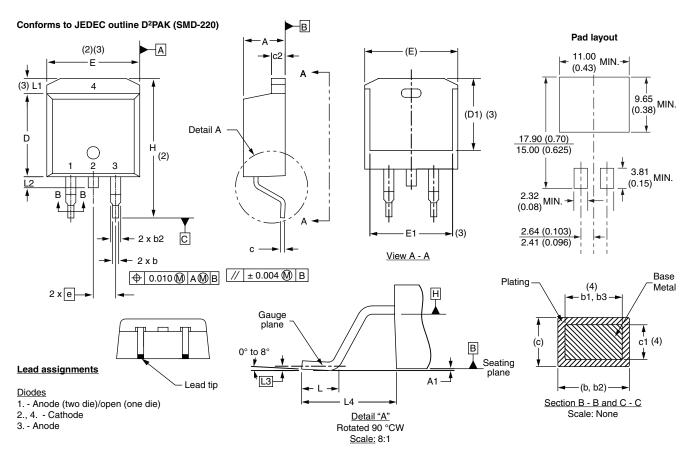
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95014</u>					
Part marking information	www.vishay.com/doc?95008				
Packaging information	www.vishay.com/doc?95032				
SPICE model	www.vishay.com/doc?95065				



## Vishay High Power Products

# **D<sup>2</sup>PAK**, **TO-262**

## **DIMENSIONS FOR D<sup>2</sup>PAK** in millimeters and inches



SYMBOL	MILLIMETERS		INC	NOTES	
	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	IETERS	INC	HES	NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$  Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

(7) Outline conforms to JEDEC outline TO-263AB

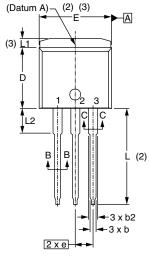
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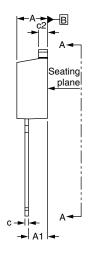
D<sup>2</sup>PAK, TO-262

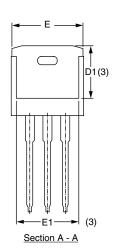


## **DIMENSIONS FOR TO-262** in millimeters and inches

# Modified JEDEC outline TO-262 (Datum A) (2) (3)







**⊕** 0.010**⋒**|A**⋒**|B

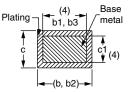
#### Lead assignments



#### **Diodes**

1. - Anode (two die)/open (one die) 2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIMETERS		INC	INCHES		
	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
Е	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54 BSC		0.100	) BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.56	3.71	0.140	0.146		

## Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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